



CAT5419

Dual Digitally Programmable Potentiometers (DPP™) with
64 Taps and 2-wire Interface



FEATURES

- Two linear-taper digital potentiometers
- 64 resistor taps per potentiometer
- End-to-end resistance 2.5kΩ, 10kΩ, 50kΩ or 100kΩ
- Potentiometer control and memory access via 2-wire interface (I²C like)
- Low wiper resistance, typically 80Ω
- Four non-volatile wiper settings for each potentiometer
- Recall of wiper settings at power up
- 2.5 to 6.0 volt operation
- Standby current less than 1μA
- 1,000,000 nonvolatile WRITE cycles
- 100 year nonvolatile memory data retention
- 24-lead SOIC, 24-lead TSSOP and BGA
- Write protection for data register

DESCRIPTION

The CAT5419 is two Digitally Programmable Potentiometers (DPP™) integrated with control logic and 16 bytes of NVRAM memory.

A separate 6-bit control register (WCR) independently controls the wiper tap position for each DPP. Associated with each wiper control register are four 6-bit non-volatile memory data registers (DR) used for storing up to four wiper settings. Writing to the wiper control register or any of the non-volatile data registers is via a 2-wire serial bus (I²C-like). On power-up, the contents of the

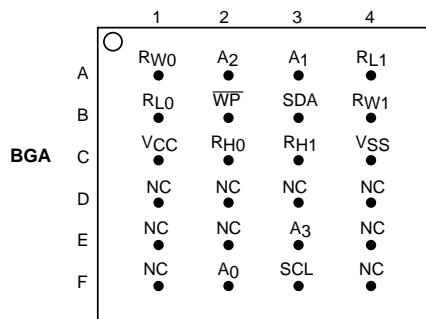
first data register (DR0) for each of the two potentiometers is automatically loaded into its respective wiper control registers (WCR).

The Write Protection (WP) pin protects against inadvertent programming of the data register.

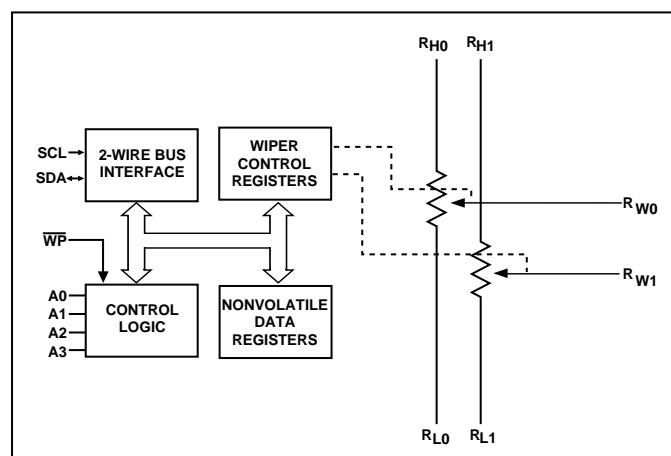
The CAT5419 can be used as a potentiometer or as a two terminal, variable resistor. It is intended for circuit level or system level adjustments in a wide variety of applications.

PIN CONFIGURATION

SOIC Package (J, W)				TSSOP Package (U, Y)			
VCC	1	24	NC	SDA	1	24	WP
RL0	2	23	NC	A1	2	23	A2
RH0	3	22	NC	RL1	3	22	RW0
RW0	4	21	NC	RH1	4	21	RH0
A2	5	20	A0	RW1	5	20	RL0
WP	6	19	NC	GND	6	CAT	VCC
CAT	7	18	A3	CAT	19	5419	18
SDA	8	17	SCL	NC	7	18	NC
A1	9	16	NC	NC	8	17	NC
RL1	10	15	NC	NC	9	16	NC
RH1	11	14	NC	NC	10	15	NC
RW1	12	13	NC	SCL	11	14	A0
GND				A3	12	13	NC



FUNCTIONAL DIAGRAM



PIN DESCRIPTION

Pin (TSSOP)	Pin (SOIC)	Pin (BGA)	Name	Function
19	1	C1	VCC	Supply Voltage
20	2	B1	R _{L0}	Low Reference Terminal for Potentiometer 0
21	3	C2	R _{H0}	High Reference Terminal for Potentiometer 0
22	4	A1	R _{W0}	Wiper Terminal for Potentiometer 0
23	5	A2	A2	Device Address
24	6	B2	WP	Write Protection
1	7	B3	SDA	Serial Data Input/Output
2	8	A3	A1	Device Address
3	9	A4	R _{L1}	Low Reference Terminal for Potentiometer 1
4	10	C3	R _{H1}	High Reference Terminal for Potentiometer 1
5	11	B4	R _{W1}	Wiper Terminal for Potentiometer 1
6	12	C4	GND	Ground
7	13	D4	NC	No Connect
8	14	E4	NC	No Connect
9	15	D3	NC	No Connect
10	16	F4	NC	No Connect
11	17	F3	SCL	Bus Serial Clock
12	18	E3	A3	Device Address
13	19	D1	NC	No Connect
14	20	F2	A0	Device Address, LSB
15	21	F1	NC	No Connect
16	22	D2	NC	No Connect
17	23	E1	NC	No Connect
18	24	E2	NC	No Connect

PIN DESCRIPTIONS**SCL: Serial Clock**

The CAT5419 serial clock input pin is used to clock all data transfers into or out of the device.

SDA: Serial Data

The CAT5419 bidirectional serial data pin is used to transfer data into and out of the device. The SDA pin is an open drain output and can be wire-OR'd with the other open drain or open collector outputs.

A0, A1, A2, A3: Device Address Inputs

These inputs set the device address when addressing multiple devices. A total of sixteen devices can be addressed on a single bus. A match in the slave address must be made with the address input in order to initiate communication with the CAT5419.

R_H, R_L: Resistor End Points

The R_H and R_L pins are equivalent to the terminal connections on a mechanical potentiometer.

R_W: Wiper

The R_W pins are equivalent to the wiper terminal of a mechanical potentiometer.

WP: Write Protect Input

The WP pin when tied low prevents non-volatile writes to the data registers (change of wiper control register is allowed) and when tied high or left floating normal read/write operations are allowed. See page 7, Write Protection for more details.

DEVICE OPERATION

The CAT5419 is two resistor arrays integrated with 2-wire serial interface logic, four 6-bit wiper control registers and sixteen 6-bit, non-volatile memory data registers. Each resistor array contains 63 separate resistive elements connected in series. The physical ends of each array are equivalent to the fixed terminals of a mechanical potentiometer (R_H and R_L). R_H and R_L are symmetrical and may be interchanged. The tap positions between and at the ends of the series resistors are connected to the output wiper terminals (R_W) by a

CMOS transistor switch. Only one tap point for each potentiometer is connected to its wiper terminal at a time and is determined by the value of the wiper control register. Data can be read or written to the wiper control registers or the non-volatile memory data registers via the 2-wire bus. Additional instructions allow data to be transferred between the wiper control registers and each respective potentiometer's non-volatile data registers. Also, the device can be instructed to operate in an "increment/decrement" mode.

ABSOLUTE MAXIMUM RATINGS*

Temperature Under Bias	-55°C to +125°C
Storage Temperature	-65°C to +150°C
Voltage on any Pin with Respect to V _{SS} ⁽¹⁾⁽²⁾	-2.0V to +V _{CC} +2.0V
V _{CC} with Respect to Ground	-2.0V to +7.0V
Package Power Dissipation Capability (T _A = 25°C)	1.0W
Lead Soldering Temperature (10 secs)	300°C
Wiper Current.....	±12mA

Note: (1) The minimum DC input voltage is -0.5V. During transitions, inputs may undershoot to -2.0V for periods of less than 20 ns.
 Maximum DC voltage on output pins is V_{CC} +0.5V, which may overshoot to V_{CC} +2.0V for periods of less than 20 ns.
 (2) Latch-up protection is provided for stresses up to 100 mA on address and data pins from -1V to V_{CC} +1V.

***COMMENT**

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions outside of those listed in the operational sections of this specification is not implied. Exposure to any absolute maximum rating for extended periods may affect device performance and reliability.

Recommended Operating Conditions:

$$V_{CC} = +2.5V \text{ to } +6.0V$$

Temperature	Min	Max
Industrial	-40°C	85°C

POTENTIOMETER CHARACTERISTICS

Over recommended operating conditions unless otherwise stated.

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
R _{POT}	Potentiometer Resistance (-00)			100		kΩ
R _{POT}	Potentiometer Resistance (-50)			50		kΩ
R _{POT}	Potentiometer Resistance (-10)			10		kΩ
R _{POT}	Potentiometer Resistance (-2.5)			2.5		kΩ
	Potentiometer Resistance Tolerance				±20	%
	R _{POT} Matching				1	%
	Power Rating	25°C, each pot			50	mW
I _W	Wiper Current				±6	mA
R _W	Wiper Resistance	I _W = ±3mA @ V _{CC} = 3V			300	Ω
R _W	Wiper Resistance	I _W = ±3mA @ V _{CC} = 5V		80	150	Ω
V _{TERM}	Voltage on any R _H or R _L Pin	V _{SS} = 0V	GND		V _{CC}	V
V _N	Noise	(1)		TBD		nV/√Hz
	Resolution				1.6	%
	Absolute Linearity (2)	R _{w(n)(actual)} - R _{(n)(expected)} ⁽⁵⁾			±1	LSB ⁽⁴⁾
	Relative Linearity ⁽³⁾	R _{w(n+1)} - [R _{w(n)} + LSB] ⁽⁵⁾			±0.2	LSB ⁽⁴⁾
T _{CRPOT}	Temperature Coefficient of R _{POT}	(1)			±300	ppm/°C
T _{CRATIO}	Ratiometric Temp. Coefficient	(1)			20	ppm/°C
C _H /C _L /C _W	Potentiometer Capacitances	(1)		10/10/25		pF
f _C	Frequency Response	R _{POT} = 50kΩ ⁽¹⁾		0.4		MHz

Note:

- (1) This parameter is tested initially and after a design or process change that affects the parameter.
- (2) Absolute linearity is utilized to determine actual wiper voltage versus expected voltage as determined by wiper position when used as a potentiometer.
- (3) Relative linearity is utilized to determine the actual change in voltage between two successive tap positions when used as a potentiometer. It is a measure of the error in step size.
- (4) LSB = R_{TOT} / 63 or (R_H - R_L) / 63, single pot
- (5) n = 0, 1, 2, ..., 63

D.C. OPERATING CHARACTERISTICS

Over recommended operating conditions unless otherwise stated.

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
I _{CC}	Power Supply Current	f _{SCL} = 400kHz			1	mA
I _{SB}	Standby Current (V _{CC} = 5.0V)	V _{IN} = GND or V _{CC} ; SDA Open			1	µA
I _{LI}	Input Leakage Current	V _{IN} = GND to V _{CC}			10	µA
I _{LO}	Output Leakage Current	V _{OUT} = GND to V _{CC}			10	µA
V _{IL}	Input Low Voltage		-1		V _{CC} x 0.3	V
V _{IH}	Input High Voltage		V _{CC} x 0.7		V _{CC} + 1.0	V
V _{OL1}	Output Low Voltage (V _{CC} = 3.0V)	I _{OL} = 3 mA			0.4	V

CAPACITANCET_A = 25°C, f = 1.0 MHz, V_{CC} = 5V

Symbol	Test	Conditions	Min	Typ	Max	Units
C _{I/O} ⁽¹⁾	Input/Output Capacitance (SDA)	V _{I/O} = 0V			8	pF
C _{IN} ⁽¹⁾	Input Capacitance (A0, A1, A2, A3, SCL, WP)	V _{IN} = 0V			6	pF

A.C. CHARACTERISTICS

Over recommended operating conditions unless otherwise stated.

Symbol	Parameter	Min	Typ	Max	Units
f _{SCL}	Clock Frequency			400	kHz
T _I ⁽¹⁾	Noise Suppression Time Constant at SCL, SDA Inputs			50	ns
t _{AA}	SLC Low to SDA Data Out and ACK Out			0.9	µs
t _{BUF} ⁽¹⁾	Time the bus must be free before a new transmission can start	1.2			µs
t _{HD:STA}	Start Condition Hold Time	0.6			µs
t _{LOW}	Clock Low Period	1.2			µs
t _{HIGH}	Clock High Period	0.6			µs
t _{SU:STA}	Start Condition SetupTime (for a Repeated Start Condition)	0.6			µs
t _{HD:DAT}	Data in Hold Time	0			ns
t _{SU:DAT}	Data in Setup Time	100			ns
t _R ⁽¹⁾	SDA and SCL Rise Time			0.3	µs
t _F ⁽¹⁾	SDA and SCL Fall Time			300	ns
t _{SU:STO}	Stop Condition Setup Time	0.6			µs
t _{DH}	Data Out Hold Time	50			ns

POWER UP TIMING (1)

Over recommended operating conditions unless otherwise stated.

Symbol	Parameter	Min	Typ	Max	Units
t _{PUR}	Power-up to Read Operation			1	ms
t _{PUW}	Power-up to Write Operation			1	ms

Note:

(1) This parameter is tested initially and after a design or process change that affects the parameter.

WRITE CYCLE LIMITS

Over recommended operating conditions unless otherwise stated.

Symbol	Parameter		Min	Typ	Max	Units
tWR	Write Cycle Time			5		ms

The write cycle is the time from a valid stop condition of a write sequence to the end of the internal program/erase cycle. During the write cycle, the bus interface circuits are disabled, SDA is allowed to remain high, and the device does not respond to its slave address.

RELIABILITY CHARACTERISTICS

Over recommended operating conditions unless otherwise stated.

Symbol	Parameter	Reference Test Method	Min	Typ	Max	Units
N _{END} ⁽¹⁾	Endurance	MIL-STD-883, Test Method 1033	1,000,000			Cycles/Byte
T _{DR} ⁽¹⁾	Data Retention	MIL-STD-883, Test Method 1008	100			Years
V _{ZAP} ⁽¹⁾	ESD Susceptibility	MIL-STD-883, Test Method 3015	2000			Volts
I _{LTH} ⁽¹⁾⁽²⁾	Latch-Up	JEDEC Standard 17	100			mA

Note:

(1) This parameter is tested initially and after a design or process change that affects the parameter.

(2) t_{PUR} and t_{PUW} are the delays required from the time V_{CC} is stable until the specified operation can be initiated.

Figure 1. Bus Timing

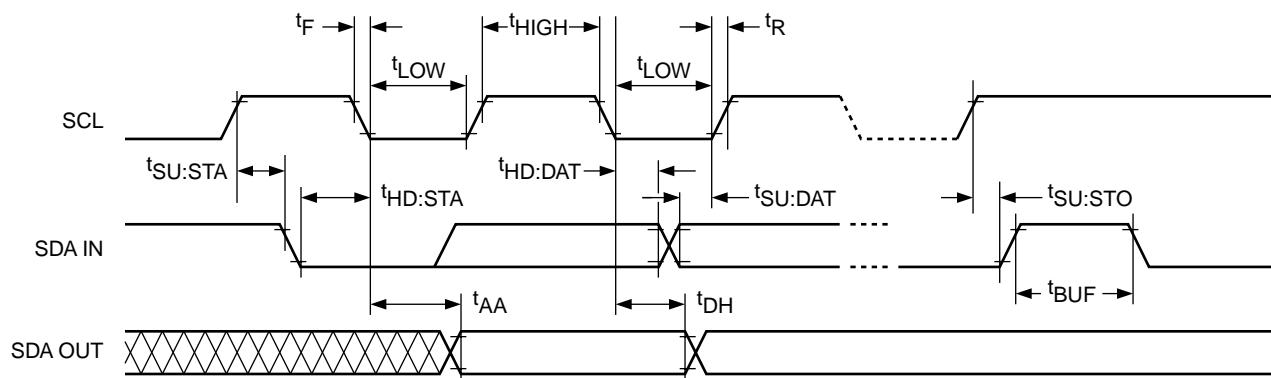


Figure 2. Write Cycle Timing

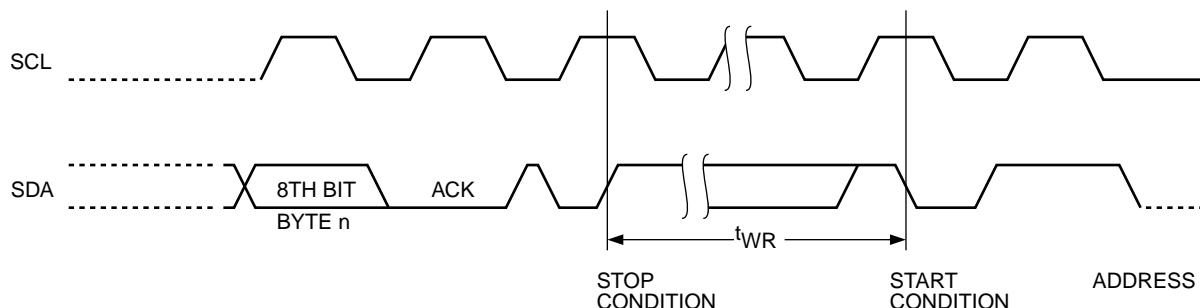
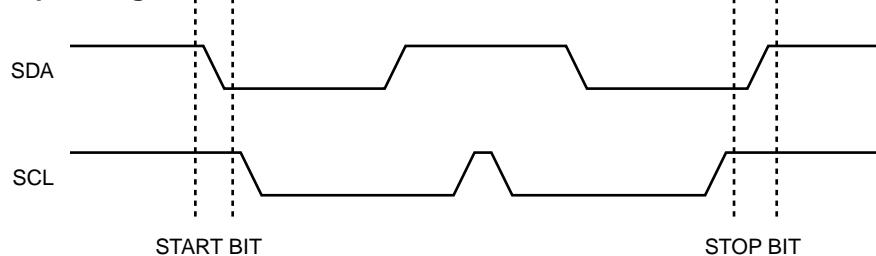


Figure 3. Start/Stop Timing



SERIAL BUS PROTOCOL

The following defines the features of the 2-wire bus protocol:

- (1) Data transfer may be initiated only when the bus is not busy.
- (2) During a data transfer, the data line must remain stable whenever the clock line is high. Any changes in the data line while the clock is high will be interpreted as a START or STOP condition.

The device controlling the transfer is a master, typically a processor or controller, and the device being controlled is the slave. The master will always initiate data transfers and provide the clock for both transmit and receive operations. Therefore, the CAT5419 will be considered a slave device in all applications.

START Condition

The START Condition precedes all commands to the device, and is defined as a HIGH to LOW transition of SDA when SCL is HIGH. The CAT5419 monitors the SDA and SCL lines and will not respond until this condition is met.

STOP Condition

A LOW to HIGH transition of SDA when SCL is HIGH determines the STOP condition. All operations must end with a STOP condition.

DEVICE ADDRESSING

The bus Master begins a transmission by sending a START condition. The Master then sends the address of

the particular slave device it is requesting. The four most significant bits of the 8-bit slave address are fixed as 0101 for the CAT5419 (see Figure 5). The next four significant bits (A3, A2, A1, A0) are the device address bits and define which device the Master is accessing. Up to sixteen devices may be individually addressed by the system. Typically, +5V and ground are hard-wired to these pins to establish the device's address.

After the Master sends a START condition and the slave address byte, the CAT5419 monitors the bus and responds with an acknowledge (on the SDA line) when its address matches the transmitted slave address.

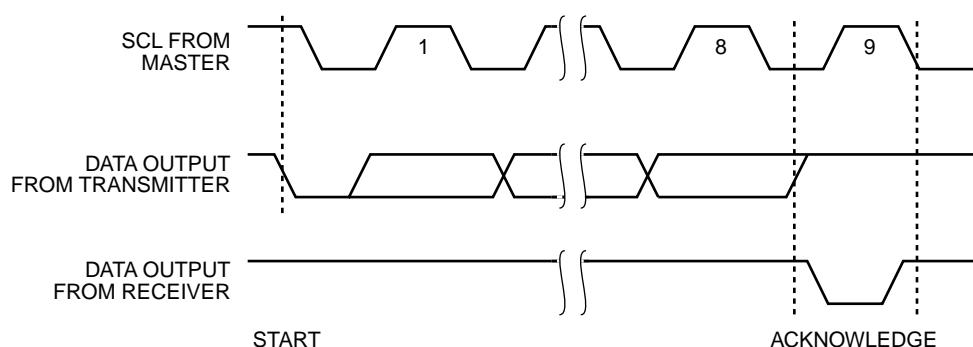
Acknowledge

After a successful data transfer, each receiving device is required to generate an acknowledge. The Acknowledging device pulls down the SDA line during the ninth clock cycle, signaling that it received the 8 bits of data.

The CAT5419 responds with an acknowledge after receiving a START condition and its slave address. If the device has been selected along with a write operation, it responds with an acknowledge after receiving each 8-bit byte.

When the CAT5419 is in a READ mode it transmits 8 bits of data, releases the SDA line, and monitors the line for an acknowledge. Once it receives this acknowledge, the CAT5419 will continue to transmit data. If no acknowledge is sent by the Master, the device terminates data transmission and waits for a STOP condition.

Figure 4. Acknowledge Timing



WRITE OPERATIONS

In the Write mode, the Master device sends the START condition and the slave address information to the Slave device. After the Slave generates an acknowledge, the Master sends the instruction byte that defines the requested operation of CAT5419. The instruction byte consist of a four-bit opcode followed by two register selection bits and two pot selection bits. After receiving another acknowledge from the Slave, the Master device transmits the data to be written into the selected register. The CAT5419 acknowledges once more and the Master generates the STOP condition, at which time if a non-volatile data register is being selected, the device begins an internal programming cycle to non-volatile memory. While this internal cycle is in progress, the device will not respond to any request from the Master device.

Acknowledge Polling

The disabling of the inputs can be used to take advantage of the typical write cycle time. Once the stop condition is

issued to indicate the end of the host's write operation, the CAT5419 initiates the internal write cycle. ACK polling can be initiated immediately. This involves issuing the start condition followed by the slave address. If the CAT5419 is still busy with the write operation, no ACK will be returned. If the CAT5419 has completed the write operation, an ACK will be returned and the host can then proceed with the next instruction operation.

WRITE PROTECTION

The Write Protection feature allows the user to protect against inadvertent programming of the non-volatile data registers. If the \overline{WP} pin is tied to LOW, the data registers are protected and become read only. Similarly, \overline{WP} pin going LOW after Start will interrupt non-volatile write to data registers, while \overline{WP} pin going LOW after internal write cycle has started will have no effect on any write operation. The CAT5419 will accept both slave addresses and instructions, but the data registers are protected from programming by the device's failure to send an acknowledge after data is received.

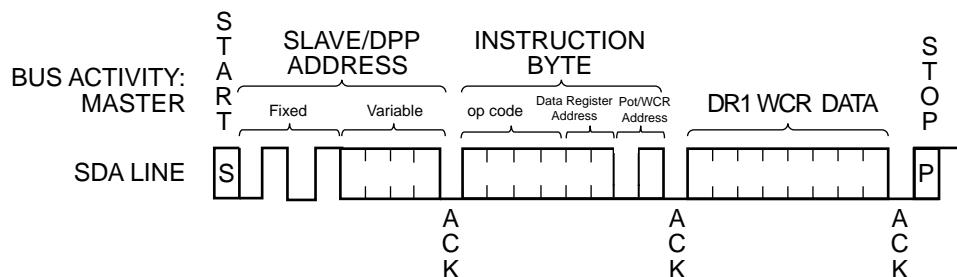
Figure 5. Slave Address Bits

CAT5419	0	1	0	1	A3	A2	A1	A0
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* A0, A1, A2 and A3 correspond to pin A0, A1, A2 and A3 of the device.

** A0, A1, A2 and A3 must compare to its corresponding hard wired input pins.

Figure 6. Write Timing



INSTRUCTION AND REGISTER DESCRIPTION

Instructions

SLAVE ADDRESS BYTE

The first byte sent to the CAT5419 from the master/processor is called the Slave/DPP Address Byte. The most significant four bits of the slave address are a device type identifier. These bits for the CAT5419 are fixed at 0101[B] (refer to Table 1).

The next four bits, A3 - A0, are the internal slave address and must match the physical device address which is defined by the state of the A3 - A0 input pins for the CAT5419 to successfully continue the command sequence. Only the device which slave address matches the incoming device address sent by the master executes the instruction. The A3 - A0 inputs can be actively driven by CMOS input signals or tied to Vcc or Vss.

Table 1. Identification Byte Format

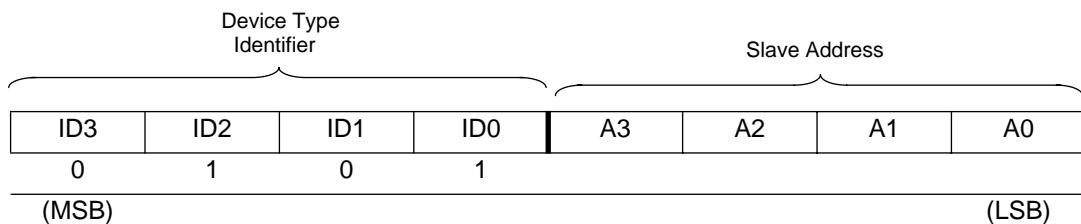
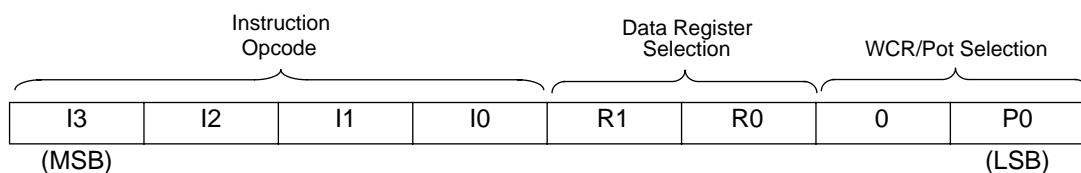


Table 2. Instruction Byte Format



INSTRUCTION BYTE

The next byte sent to the CAT5419 contains the instruction and register pointer information. The four most significant bits used provide the instruction opcode I [3:0]. The R1 and R0 bits point to one of the four data registers of each associated potentiometer. The least two significant bits point to one of two Wiper Control Registers. The format is shown in Table 2.

Data Register Selection

Data Register Selected	R1	R0
DR0	0	0
DR1	0	1
DR2	1	0
DR3	1	1

WIPER CONTROL AND DATA REGISTERS

Wiper Control Register (WCR)

The CAT5419 contains two 6-bit Wiper Control Registers, one for each potentiometer. The Wiper Control Register output is decoded to select one of 64 switches along its resistor array. The contents of the WCR can be altered in four ways: it may be written by the host via Write Wiper Control Register instruction; it may be written by transferring the contents of one of four associated Data Registers via the XFR Data Register instruction, it can be modified one step at a time by the Increment/decrement instruction (see Instruction section for more details). Finally, it is loaded with the content of its data register zero (DR0) upon power-up.

The Wiper Control Register is a volatile register that loses its contents when the CAT5419 is powered-down. Although the register is automatically loaded with the value in DR0 upon power-up, this may be different from the value present at power-down.

Data Registers (DR)

Each potentiometer has four 6-bit non-volatile Data Registers. These can be read or written directly by the host. Data can also be transferred between any of the

four Data Registers and the associated Wiper Control Register. Any data changes in one of the Data Registers is a non-volatile operation and will take a maximum of 5ms.

If the application does not require storage of multiple settings for the potentiometer, the Data Registers can be used as standard memory locations for system parameters or user preference data.

INSTRUCTIONS

Four of the nine instructions are three bytes in length. These instructions are:

- **Read Wiper Control Register** - read the current wiper position of the selected potentiometer in the WCR
- **Write Wiper Control Register** - change current wiper position in the WCR of the selected potentiometer
- **Read Data Register** - read the contents of the selected Data Register
- **Write Data Register** - write a new value to the selected Data Register

The basic sequence of the three byte instructions is illustrated in Figure 8. These three-byte instructions

Table 3. Instruction Set

Instruction	Instruction Set								Operation
	I3	I2	I1	I0	R1	R0	0	WCR0/ P0	
Read Wiper Control Register	1	0	0	1	0	0	0	1/0	Read the contents of the Wiper Control Register pointed to by P0
Write Wiper Control Register	1	0	1	0	0	0	0	1/0	Write new value to the Wiper Control Register pointed to by P0
Read Data Register	1	0	1	1	1/0	1/0	0	1/0	Read the contents of the Data Register pointed to by P0 and R1-R0
Write Data Register	1	1	0	0	1/0	1/0	0	1/0	Write new value to the Data Register pointed to by P0 and R1-R0
XFR Data Register to Wiper Control Register	1	1	0	1	1/0	1/0	0	1/0	Transfer the contents of the Data Register pointed to by P0 and R1-R0 to its associated Wiper Control Register
XFR Wiper Control Register to Data Register	1	1	1	0	1/0	1/0	0	1/0	Transfer the contents of the Wiper Control Register pointed to by P0 to the Data Register pointed to by R1-R0
Gang XFR Data Registers to Wiper Control Registers	0	0	0	1	1/0	1/0	0	0	Transfer the contents of the Data Registers pointed to by R1-R0 of both pots to their respective Wiper Control Register
Gang XFR Wiper Control Registers to Data Register	1	0	0	0	1/0	1/0	0	0	Transfer the contents of both Wiper Control Registers to their respective data Registers pointed to by R1-R0 of both pots
Increment/Decrement Wiper Control Register	0	0	1	0	0	0	0	1/0	Enable Increment/decrement of the Control Latch pointed to by P0

Note: 1/0 = data is one or zero

exchange data between the WCR and one of the Data Registers. The WCR controls the position of the wiper. The response of the wiper to this action will be delayed by t_{WRL} . A transfer from the WCR (current wiper position), to a Data Register is a write to non-volatile memory and takes a maximum of t_{WR} to complete. The transfer can occur between one of the potentiometers and one of its associated registers; or the transfer can occur between all potentiometers and one associated register.

Four instructions require a two-byte sequence to complete, as illustrated in Figure 7. These instructions transfer data between the host/processor and the CAT5419; either between the host and one of the data registers or directly between the host and the Wiper Control Register. These instructions are:

— XFR Data Register to Wiper Control Register

This transfers the contents of one specified Data Register to the associated Wiper Control Register.

— XFR Wiper Control Register to Data Register

This transfers the contents of the specified Wiper Control Register to the specified associated Data Register.

— Global XFR Data Register to Wiper Control Register

This transfers the contents of specified Data Registers to the associated Wiper Control Registers.

— Global XFR Wiper Counter Register to Data Register

This transfers the contents of all Wiper Control Registers to the specified associated Data Registers.

INCREMENT/DECREMENT COMMAND

The final command is Increment/Decrement (Figure 5 and 9). The Increment/Decrement command is different from the other commands. Once the command is issued and the CAT5419 has responded with an acknowledge, the master can clock the selected wiper up and/or down in one segment steps; thereby providing a fine tuning capability to the host. For each SCL clock pulse (t_{HIGH}) while SDA is HIGH, the selected wiper will move one resistor segment towards the R_H terminal. Similarly, for each SCL clock pulse while SDA is LOW, the selected wiper will move one resistor segment towards the R_L terminal.

See Instructions format for more detail.

Figure 7. Two-Byte Instruction Sequence

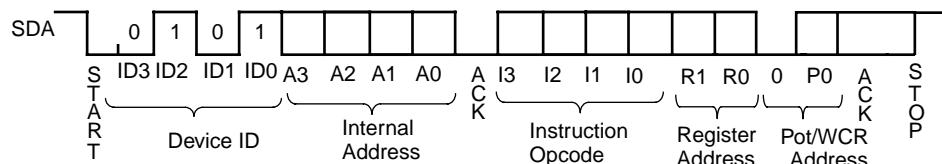


Figure 8. Three-Byte Instruction Sequence

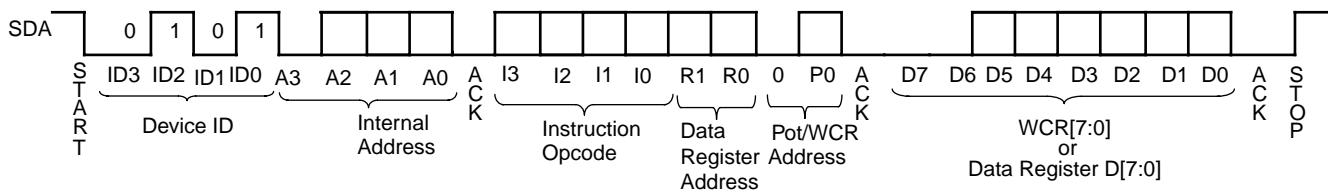


Figure 9. Increment/Decrement Instruction Sequence

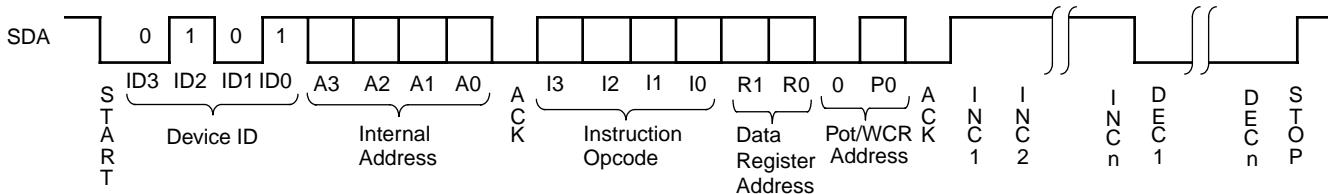
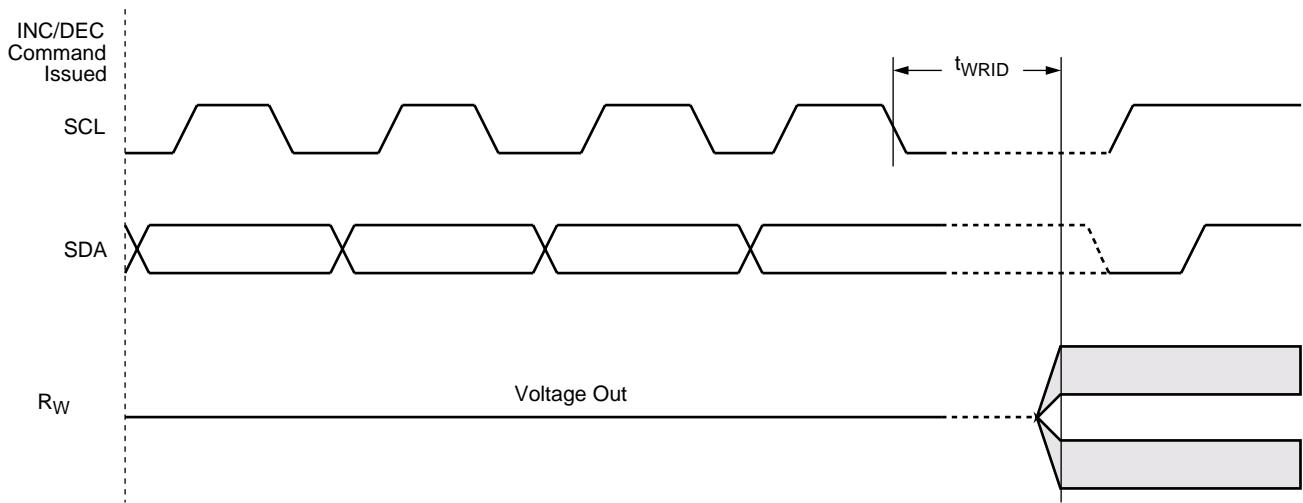


Figure 10. Increment/Decrement Timing Limits

INSTRUCTION FORMAT

Read Wiper Control Register (WCR)

S T A R T	DEVICE ADDRESSES						A C K	INSTRUCTION						A C K	DATA						A C K	S T O P			
	0	1	0	1	A3	A2	A1	A0	1	0	0	1	0	0	0	P0	7	6	5	4	3	2	1	0	
0	1	0	1	A3	A2	A1	A0	1	0	0	1	0	0	0	P0	7	6	5	4	3	2	1	0	0	0

Write Wiper Control Register (WCR)

S T A R T	DEVICE ADDRESSES						A C K	INSTRUCTION						A C K	DATA						A C K	S T O P			
	0	1	0	1	A3	A2	A1	A0	1	0	1	0	0	0	0	P0	7	6	5	4	3	2	1	0	
0	1	0	1	A3	A2	A1	A0	1	0	1	0	0	0	0	P0	7	6	5	4	3	2	1	0	0	0

Read Data Register (DR)

S T A R T	DEVICE ADDRESS						A C K	INSTRUCTION						A C K	DATA						A C K	S T O P			
	0	1	0	1	A3	A2	A1	A0	1	0	1	1	R1	R0	0	P0	7	6	5	4	3	2	1	0	
0	1	0	1	A3	A2	A1	A0	1	0	1	1	R1	R0	0	P0	7	6	5	4	3	2	1	0	0	0

Write Data Register (DR)

S T A R T	DEVICE ADDRESS						A C K	INSTRUCTION						A C K	DATA						A C K	S T O P			
	0	1	0	1	A3	A2	A1	A0	1	1	0	0	R1	R0	0	P0	7	6	5	4	3	2	1	0	
0	1	0	1	A3	A2	A1	A0	1	1	0	0	R1	R0	0	P0	7	6	5	4	3	2	1	0	0	0

INSTRUCTION FORMAT (continued)**Global Transfer Data Register (DR) to Wiper Control Register (WCR)**

S	DEVICE ADDRESS						A	INSTRUCTION						A	S			
T	0	1	0	1	A3	A2	A1	A0	C	0	0	0	1	R1	R0	0	C	K
A									A							A		
R									A							A		
T									A							A		

Global Transfer Wiper Control Register (WCR) to Data Register (DR)

S	DEVICE ADDRESS						A	INSTRUCTION						A	S			
T	0	1	0	1	A3	A2	A1	A0	C	1	0	0	0	R1	R0	0	C	K
A									A							A		
R									A							A		
T									A							A		

Transfer Wiper Control Register (WCR) to Data Register (DR)

S	DEVICE ADDRESS						A	INSTRUCTION						A	S			
T	0	1	0	1	A3	A2	A1	A0	C	1	1	1	0	R1	R0	0	C	K
A									A							A		
R									A							A		
T									A							A		

Transfer Data Register (DR) to Wiper Control Register (WCR)

S	DEVICE ADDRESS						A	INSTRUCTION						A	S			
T	0	1	0	1	A3	A2	A1	A0	C	1	1	0	1	R1	R0	0	C	K
A									A							A		
R									A							A		
T									A							A		

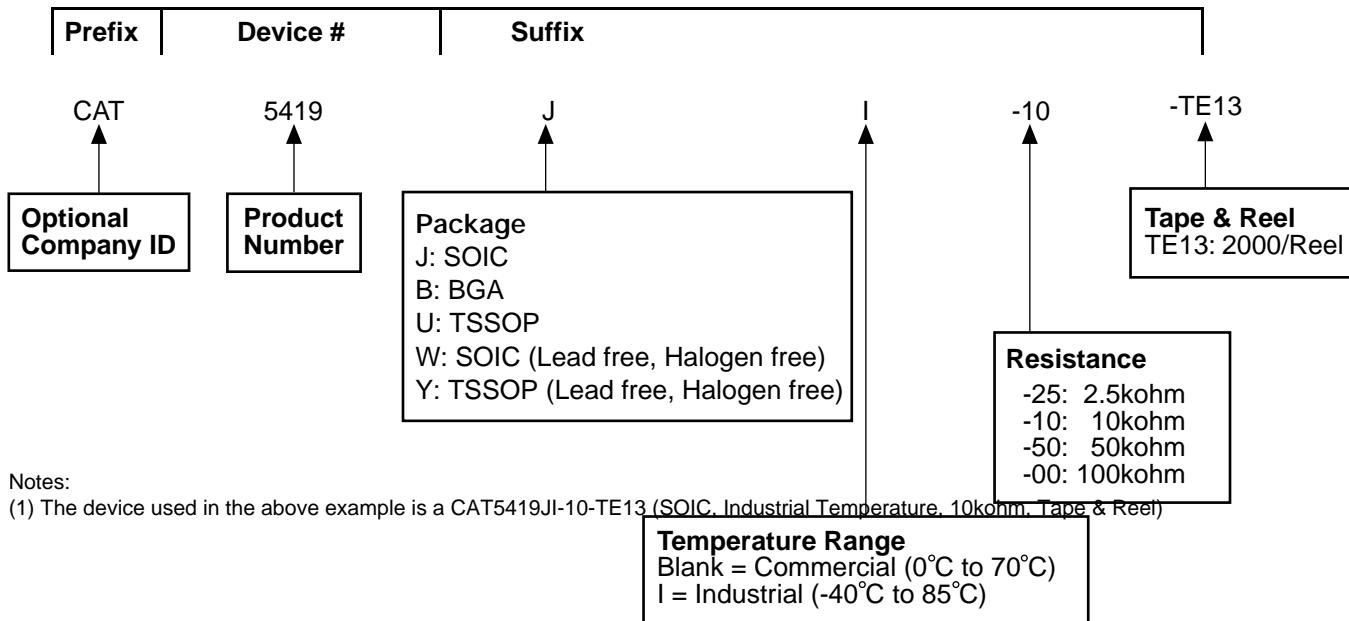
Increment (I)/Decrement (D) Wiper Control Register (WCR)

S	DEVICE ADDRESS						A	INSTRUCTION						A	DATA		A	S			
T	0	1	0	1	A3	A2	A1	A0	C	0	0	1	0	0	0	P0	C	I/D	I/D	A	K
A									A							A			A		
R									A							A			A		
T									A							A			A		

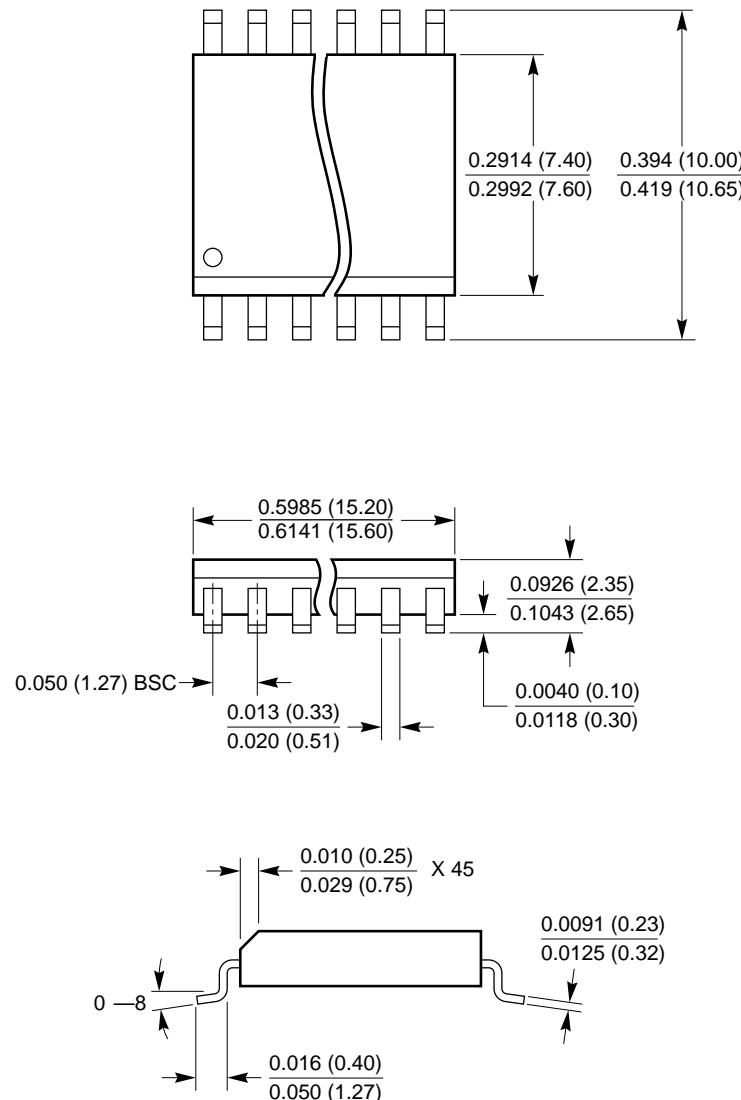
Notes:

- (1) Any write or transfer to the Non-volatile Data Registers is followed by a high voltage cycle after a STOP has been issued.

ORDERING INFORMATION

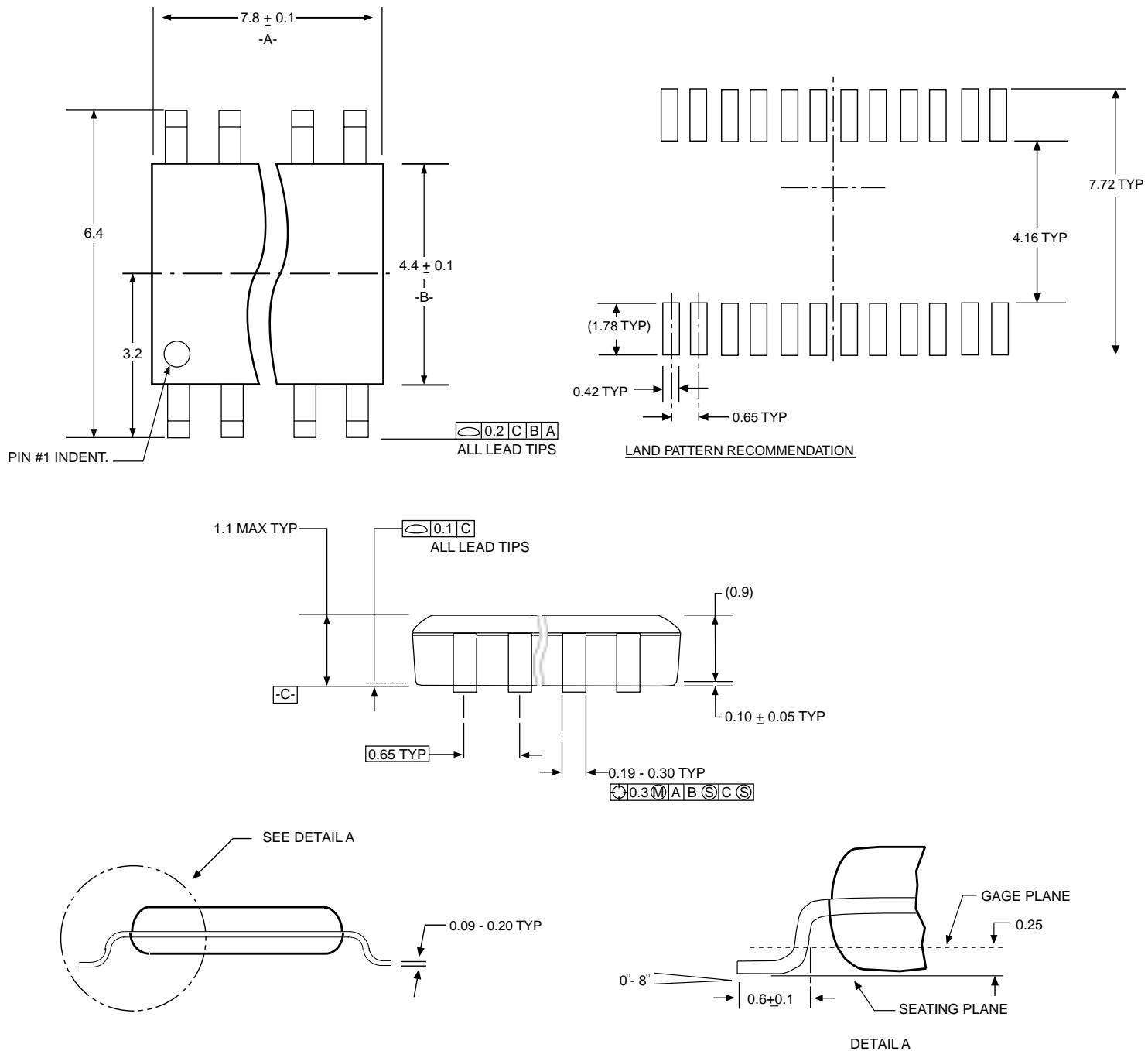


PACKAGING INFORMATION
24-LEAD 300 MIL WIDE SOIC (J)



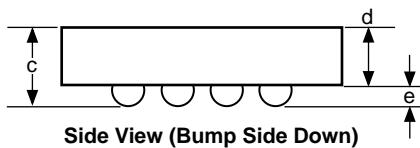
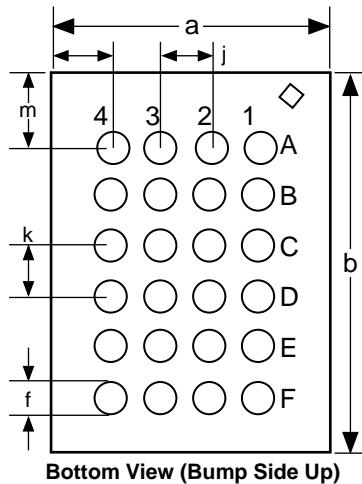
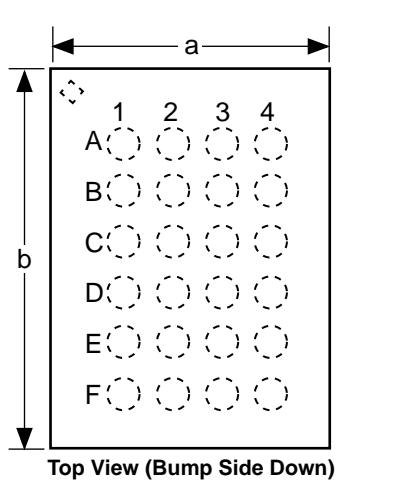
PACKAGING INFORMATION CON'T

24 Lead TSSOP (U)



PACKAGING INFORMATION CON'T

24 Ball BGA



Note: Drawing not to scale
 \diamond = Die orientation mark

	Symbol	Millimeters			Inches		
		Min	Nom	Max	Nom	Min	Max
Package Body Dimension X	a	TBD	TBD	TBD	TBD	TBD	TBD
Package Body Dimension Y	b	TBD	TBD	TBD	TBD	TBD	TBD
Package Height	c	0.635	0.505	0.765	0.02500	0.01988	0.03012
Package Body Thickness	d	0.433	0.395	0.471	0.01705	0.01555	0.01854
Ball Height	e	0.202	0.110	0.294	0.00795	0.00433	0.01157
Ball Diameter	f	0.284	0.180	0.388	0.01118	0.00709	0.01528
Total Ball Count	g	24					
Ball Count X Axis	h	4					
Ball Count Y Axis	i	6					
Pins Pitch X Axis	j	0.5					
Pins Pitch Y Axis	k	0.5					
Edge to Ball Center (Corner) Distance Along X	l	TBD	TBD	TBD	TBD	TBD	TBD
Edge to Ball Center (Corner) Distance Along Y	m	TBD	TBD	TBD	TBD	TBD	TBD

REVISION HISTORY

Date	Rev.	Reason
10/8/2003	E	Updated Features Updated Description
04/01/04	F	Eliminated data sheet designation Update Description Update Pin Description Update Device Operation Update Absolute Maximum Ratings Update Recommended Operating Conditions Update Potentiometer Characteristics Update Write Protection Update Instructions Update Ordering Information

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